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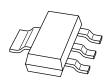
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PBSS305NZ 80 V, 5.1 A NPN low V_{CEsat} (BISS) transistor Rev. 02 — 8 December 2009

Product data sheet

Product profile 1.

1.1 General description

NPN low V_{CEsat} Breakthrough In Small Signal (BISS) transistor in a SOT223 (SC-73) small Surface-Mounted Device (SMD) plastic package.

PNP complement: PBSS305PZ.

1.2 Features

- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability I_C and I_{CM}
- High collector current gain (h_{FE}) at high I_C
- High efficiency due to less heat generation
- Smaller required Printed-Circuit Board (PCB) area than for conventional transistors

1.3 Applications

- High-voltage DC-to-DC conversion
- High-voltage MOSFET gate driving
- High-voltage motor control
- High-voltage power switches (e.g. motors, fans)
- Automotive applications

1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CEO}	collector-emitter voltage	open base	-	-	80	V
I _C	collector current		-	-	5.1	А
I _{CM}	peak collector current	single pulse; $t_p \leq 1 \text{ ms}$	-	-	10.2	A
R _{CEsat}	collector-emitter saturation resistance	I _C = 4 A; I _B = 200 mA	[1] -	40	56	mΩ

[1] Pulse test: $t_p \le 300 \ \mu s$; $\delta \le 0.02$.



80 V, 5.1 A NPN low V_{CEsat} (BISS) transistor

2. Pinning information

Pin	Description	Simplified outline	Symbol	
1	base			
2	collector		2, 4	
3	emitter		1	
4	collector		3	
			sym016	

3. Ordering information

Table 3. Ordering information						
Type number	Package	je				
	Name	Description	Version			
PBSS305NZ	SC-73	plastic surface-mounted package with increased heatsink; 4 leads	SOT223			

4. Marking

Table 4.	Marking codes	
Type num	ber	Marking code
PBSS305	NZ	S305NZ

80 V, 5.1 A NPN low V_{CEsat} (BISS) transistor

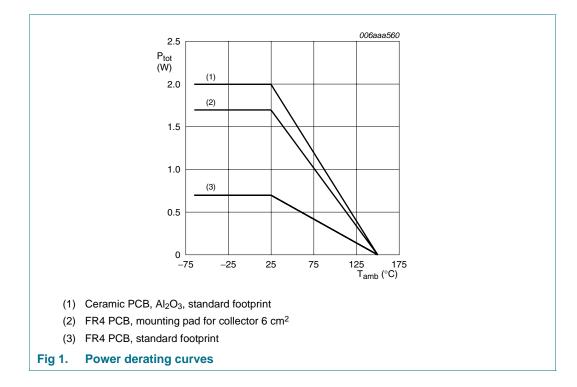
5. Limiting values

Table 5.Limiting valuesIn accordance with the Absolute Maximum Rating System (IEC 60134).					
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CBO}	collector-base voltage	open emitter	-	80	V
V _{CEO}	collector-emitter voltage	open base	-	80	V
V _{EBO}	emitter-base voltage	open collector	-	5	V
I _C	collector current		-	5.1	А
I _{CM}	peak collector current	single pulse; $t_p \leq 1 ms$	-	10.2	A
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> -	0.7	W
			[2] _	1.7	W
			[3] _	2.0	W
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm².

[3] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.



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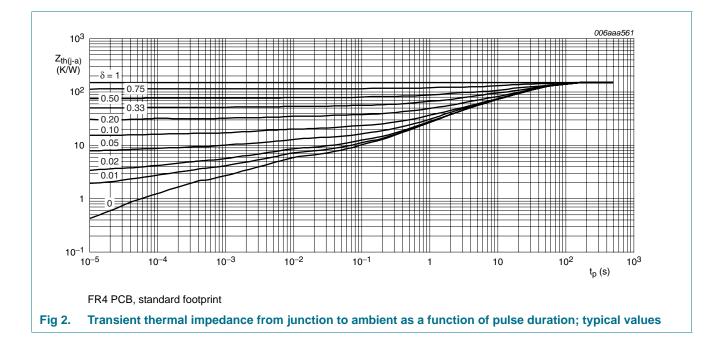
6. Thermal characteristics

Table 6.	Thermal characteristics	5				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	<u>[1]</u> -	-	179	K/W
			[2] _	-	74	K/W
			[3] _	-	63	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		-	-	15	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

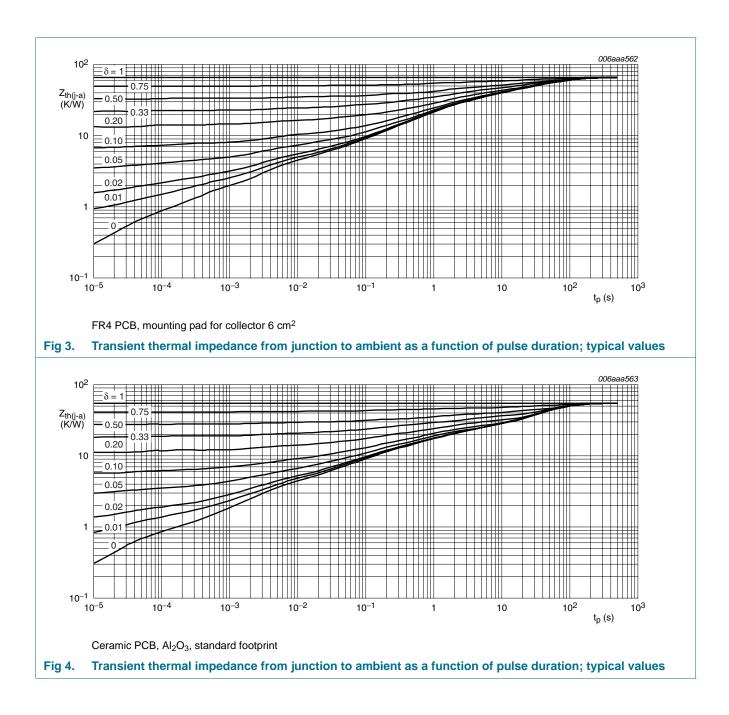
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm².

[3] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.



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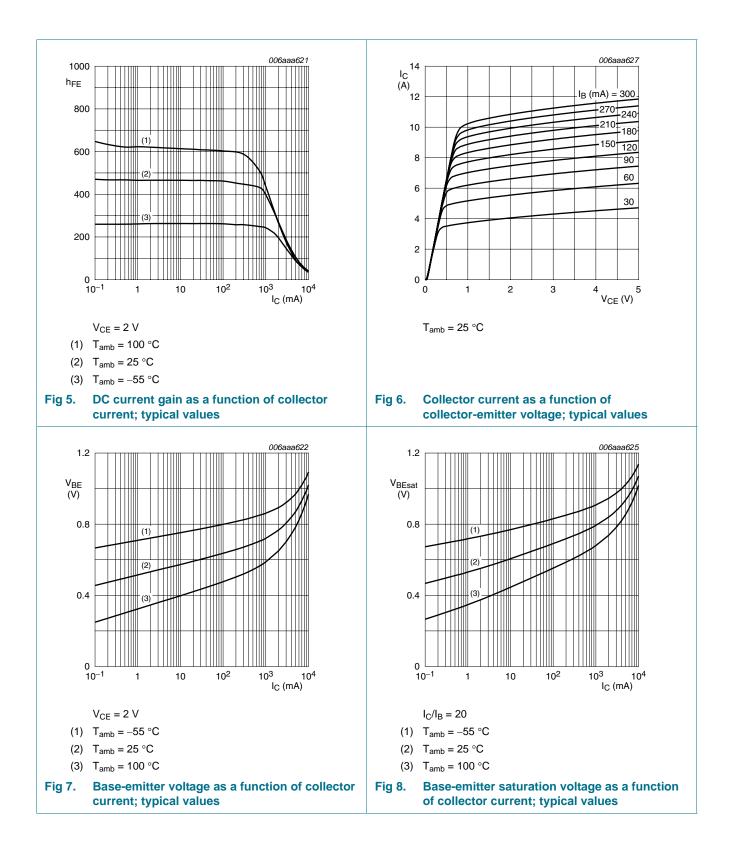
7. Characteristics

Symbol	Parameter	Conditions	Ν	Min	Тур	Max	Unit
I _{CBO}	collector-base cut-off current	$V_{CB} = 80 \text{ V}; I_E = 0 \text{ A}$	-		-	100	nA
		$V_{CB} = 80 \text{ V}; I_E = 0 \text{ A};$ $T_j = 150 \text{ °C}$	-		-	50	μA
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 V; I_C = 0 A$	-		-	100	nA
h _{FE}	DC current gain	$V_{CE} = 2 \text{ V}; I_{C} = 0.5 \text{ A}$	<u>[1]</u> 3	300	470	-	
		$V_{CE} = 2 \text{ V}; I_{C} = 1 \text{ A}$	<u>[1]</u> 2	250	420	-	
		$V_{CE} = 2 \text{ V}; I_{C} = 2 \text{ A}$	<u>[1]</u> 1	80	280	-	
		$V_{CE} = 2 \text{ V}; I_{C} = 4 \text{ A}$	<u>[1]</u> g	90	140	-	
		$V_{CE} = 2 \text{ V}; I_{C} = 6 \text{ A}$	<u>[1]</u> 5	50	80	-	
V _{CEsat}	collector-emitter saturation voltage	I _C = 0.5 A; I _B = 50 mA	<u>[1]</u> _		25	40	mV
		I _C = 1 A; I _B = 50 mA	<u>[1]</u> _		50	70	mV
		I _C = 1 A; I _B = 10 mA	<u>[1]</u> _		85	120	mV
		I _C = 2 A; I _B = 40 mA	<u>[1]</u> _		105	150	mV
		I _C = 4 A; I _B = 200 mA	<u>[1]</u> _		160	225	mV
		I _C = 4 A; I _B = 400 mA	<u>[1]</u> _		150	210	mV
		I _C = 4 A; I _B = 80 mA	<u>[1]</u> _		225	340	mV
		I _C = 5.1 A; I _B = 255 mA	<u>[1]</u> -		190	270	mV
R _{CEsat}	collector-emitter saturation resistance	$I_{C} = 4 \text{ A}; I_{B} = 200 \text{ mA}$	<u>[1]</u> -		40	56	mΩ
		I _C = 4 A; I _B = 80 mA	<u>[1]</u> -		56	85	mΩ
V _{BEsat}	base-emitter saturation voltage	I _C = 1 A; I _B = 100 mA	<u>[1]</u> -		0.82	0.9	V
		$I_{C} = 4 \text{ A}; I_{B} = 400 \text{ mA}$	<u>[1]</u> -		0.94	1.05	V
V _{BEon}	base-emitter turn-on voltage	$V_{CE} = 2 \text{ V}; \text{ I}_{C} = 2 \text{ A}$	<u>[1]</u> -		0.77	0.85	V
t _d	delay time	V_{CC} = 12.5 V; I _C = 3 A;	-		15	-	ns
t _r	rise time	[−] I _{Bon} = 0.15 A; - I _{Boff} = −0.15 A	-		200	-	ns
t _{on}	turn-on time	$I_{Boff} = -0.13 \text{ A}$	-		215	-	ns
t _s	storage time		-		310	-	ns
t _f	fall time		-		245	-	ns
t _{off}	turn-off time		-		555	-	ns
f _T	transition frequency	$V_{CE} = 10 \text{ V}; I_{C} = 100 \text{ mA};$ f = 100 MHz	-		110	-	MHz
C _c	collector capacitance	$V_{CB} = 10 \text{ V}; \text{ I}_{E} = \text{i}_{e} = 0 \text{ A};$ f = 1 MHz	-		30	50	pF

[1] Pulse test: $t_p \le 300 \ \mu s; \ \delta \le 0.02.$

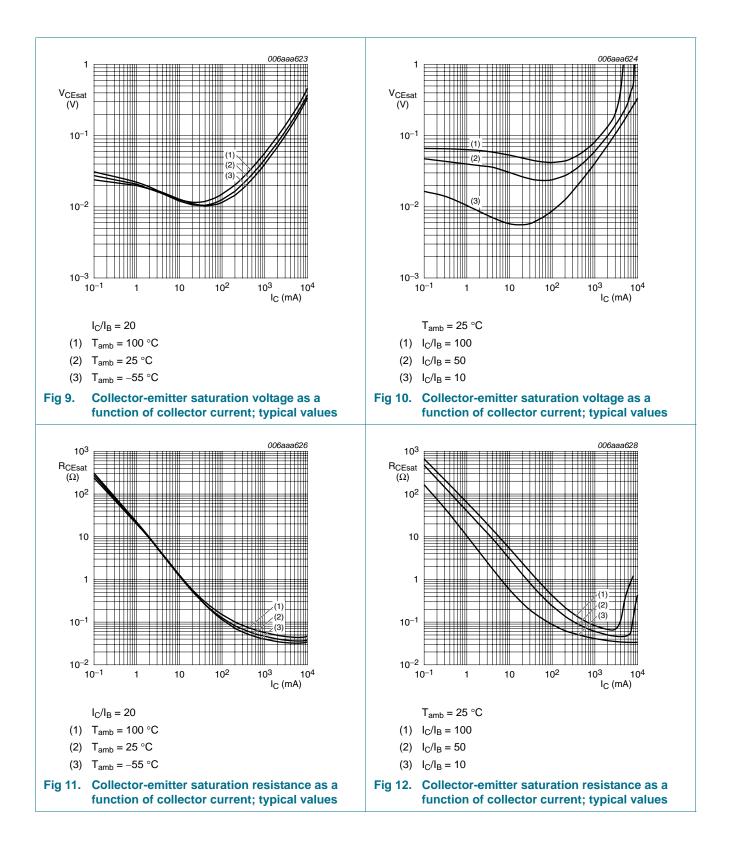
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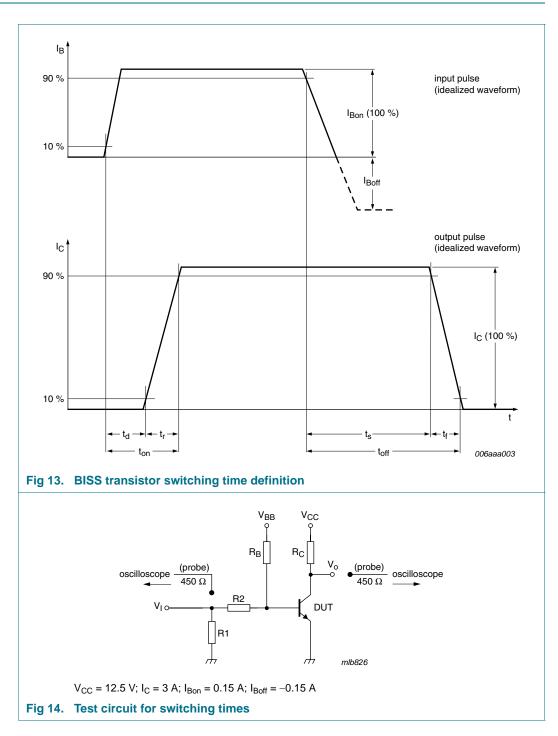
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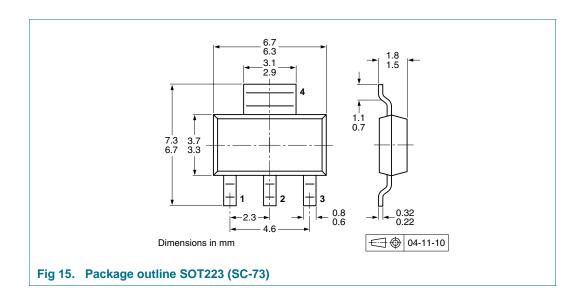
80 V, 5.1 A NPN low V_{CEsat} (BISS) transistor

8. Test information



80 V, 5.1 A NPN low V_{CEsat} (BISS) transistor

9. Package outline



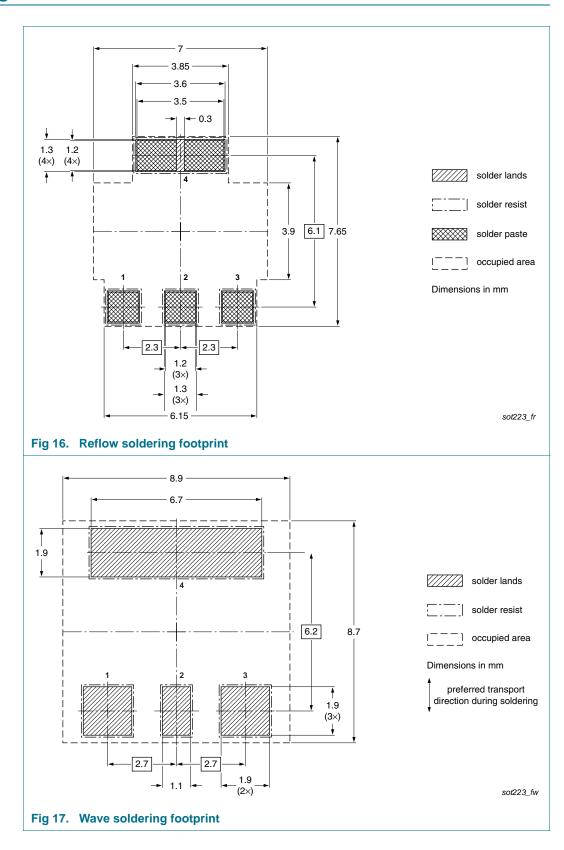
10. Packing information

Table 8. Packing methods The indicated -xxx are the last three digits of the 12NC ordering code.[1] Type number Package Description Packing quantity 1000 4000 PBSS305NZ SOT223 8 mm pitch, 12 mm tape and reel -115 -135

[1] For further information and the availability of packing methods, see <u>Section 14</u>.

80 V, 5.1 A NPN low V_{CEsat} (BISS) transistor

11. Soldering





80 V, 5.1 A NPN low V_{CEsat} (BISS) transistor

12. Revision history

Table 9. Revision	history					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
PBSS305NZ_2	20091208	Product data sheet	-	PBSS305NZ_1		
Modifications:		eet was changed to reflect w legal definitions and disc				
	 Figure 16 "Reflow soldering footprint": updated 					
	 Figure 17 "W 	/ave soldering footprint": u	odated			
PBSS305NZ_1	20060919	Product data sheet	-	-		

80 V, 5.1 A NPN low V_{CEsat} (BISS) transistor

13. Legal information

Data sheet status 13.1

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

The term 'short data sheet' is explained in section "Definitions". [2]

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://w

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PBSS305NZ 2

PBSS305NZ

80 V, 5.1 A NPN low V_{CEsat} (BISS) transistor

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